

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of: John Commander, et al. Art Unit: 1753
Serial No.: 10/091,106
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For: DEFECT REDUCTION IN ELECTRODEPOSITED
COPPER FOR SEMICONDUCTOR APPLICATIONS
Examiner: Edna Wong

June 11, 2007

AMENDMENT I

In response to the Office action of February 9, 2007,
please consider the following amendments and remarks.

Amendments to the claims are reflected in the listing of
the claims that begins on page 2 of this paper.

Remarks begin on page 7 of this paper.

Conclusion begins on page 26 of this paper.